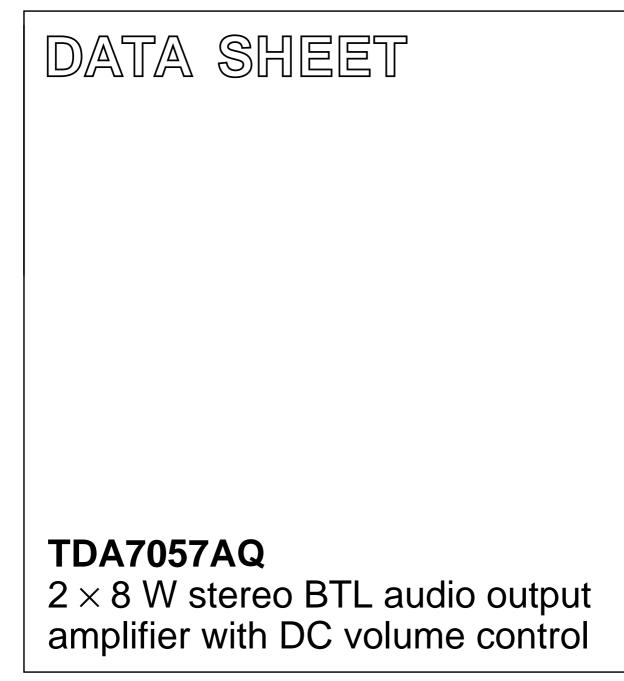
INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 July 15 File under Integrated Circuits, IC01 1998 Apr 07



TDA7057AQ

FEATURES

- DC volume control
- Few external components
- Mute mode
- Thermal protection
- Short-circuit proof
- No switch-on and switch-off clicks
- Good overall stability
- Low power consumption
- Low HF radiation
- ESD protected on all pins.

QUICK REFERENCE DATA

GENERAL DESCRIPTION

The TDA7057AQ is a stereo BTL output amplifier with DC volume control. The device is designed for use in TVs and monitors, but is also suitable for battery-fed portable recorders and radios.

Missing Current Limiter (MCL)

A MCL protection circuit is built-in. The MCL circuit is activated when the difference in current between the output terminal of each amplifier exceeds 100 mA (typical 300 mA). This level of 100 mA allows for single-ended headphone applications.

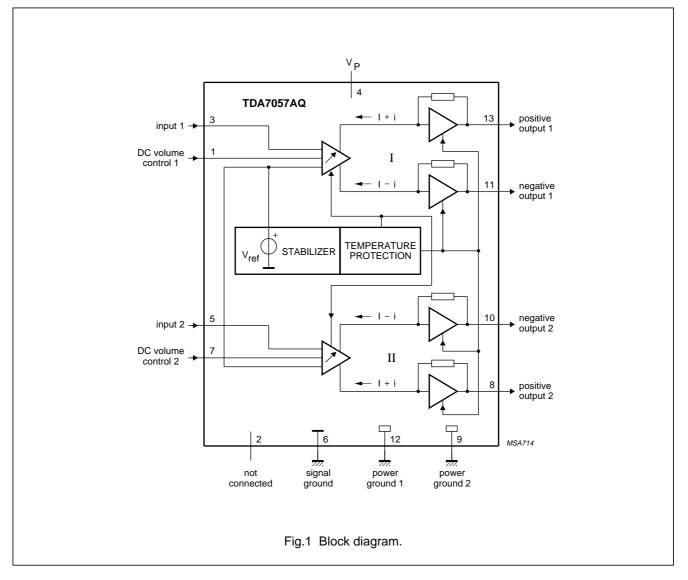
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	supply voltage		4.5	_	18	V
Pout	output power	$V_{P} = 12 \text{ V}; \text{ R}_{L} = 16 \Omega$	3.0	3.5	-	W
		$V_P = 12 \text{ V}; \text{ R}_L = 8 \Omega$	-	5.3	-	W
		$V_P = 15 \text{ V}; \text{ R}_L = 8 \Omega$	_	8	_	W
G _v	voltage gain		39.5	40.5	41.5	dB
ΔG_v	voltage gain control		68	73.5	-	dB
I _{q(tot)}	total quiescent current	V _P = 12 V; R _L = ∞	_	22	25	mA
THD	total harmonic distortion	P _o = 0.5 W	_	0.3	1	%

ORDERING INFORMATION

TYPE	PACKAGE							
NUMBER	NAME	VERSION						
TDA7057AQ	DBS13P	plastic DIL-bent-SIL power package; 13 leads (lead length 12 mm)	SOT141-6					

TDA7057AQ

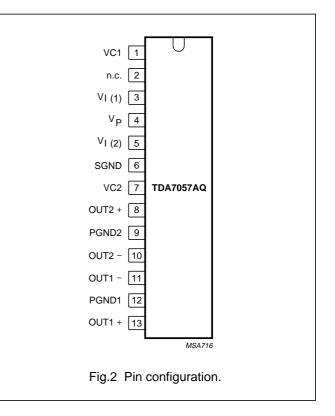
BLOCK DIAGRAM



PINNING

SYMBOL	PIN	DESCRIPTION
VC1	1	DC volume control 1
n.c.	2	not connected
V _{I (1)}	3	voltage input 1
V _P	4	positive supply voltage
V _{I (2)}	5	voltage input 2
SGND	6	signal ground
VC2	7	DC volume control 2
OUT2+	8	positive output 2
PGND2	9	power ground 2
OUT2-	10	negative output 2
OUT1-	11	negative output 1
PGND1	12	power ground 1
OUT1+ 13		positive output 1

TDA7057AQ



FUNCTIONAL DESCRIPTION

The TDA7057AQ is a stereo output amplifier with two DC volume control stages. The device is designed for TVs and monitors, but is also suitable for battery-fed portable recorders and radios.

In conventional DC volume control circuits the control or input stage is AC-coupled to the output stage via external capacitors to keep the offset voltage low.

In the TDA7057AQ the two DC volume control stages are integrated into the input stages so that no coupling capacitors are required and a low offset voltage is still maintained. The minimum supply voltage also remains low.

The BTL principle offers the following advantages:

- · Lower peak value of the supply current
- The frequency of the ripple on the supply voltage is twice the signal frequency.

Consequently, a reduced power supply with smaller capacitors can be used which results in cost reductions.

For portable applications there is a trend to decrease the supply voltage, resulting in a reduction of output power at conventional output stages. Using the BTL principle increases the output power.

The maximum gain of the amplifier is fixed at 40.5 dB. The DC volume control stages have a logarithmic control characteristic. Therefore, the total gain can be controlled from +40.5 dB to -33 dB. If the DC volume control voltage falls below 0.4 V, the device will switch to the mute mode.

The amplifier is a short-circuit protected to ground, V_P and across the load. A thermal protection circuit is also implemented. If the crystal temperature rises above +150 °C the gain will be reduced, thereby reducing the output power.

Special attention is given to switch-on and switch-off clicks, low HF radiation and a good overall stability.

TDA7057AQ

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
VP	supply voltage		-	18	V
I _{ORM}	repetitive peak output current		-	1.25	A
I _{OSM}	non-repetitive peak output current		-	1.5	A
P _{tot}	total power dissipation	T _{case} < 60 °C	-	22.5	W
T _{amb}	operating ambient temperature		-40	+85	°C
T _{stg}	storage temperature		-55	+150	°C
T _{vj}	virtual junction temperature		-	150	°C
t _{sc}	short-circuit time		-	1	hr
V _n	input voltage pins 1, 3, 5 and 7		_	5	V

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-c}	thermal resistance from junction to case	4	K/W
R _{th j-a}	thermal resistance from junction to ambient in free air	40	K/W

Power dissipation

Assume V_P = 12 V and R_L = 16 $\Omega.$ The maximum sine wave dissipation is 2 \times 1.8 W = 3.6 W.

At $T_{amb(max)} = 60$ °C:

 $R_{th tot} = (150 - 60)/3.6 = 25 \text{ K/W}.$

 $R_{th tot} = R_{th j-c} + R_{th c-hs} + R_{th hs}.$

 $R_{th c-hs} + R_{th hs} = 25 - 4 = 21 \text{ K/W}.$

TDA7057AQ

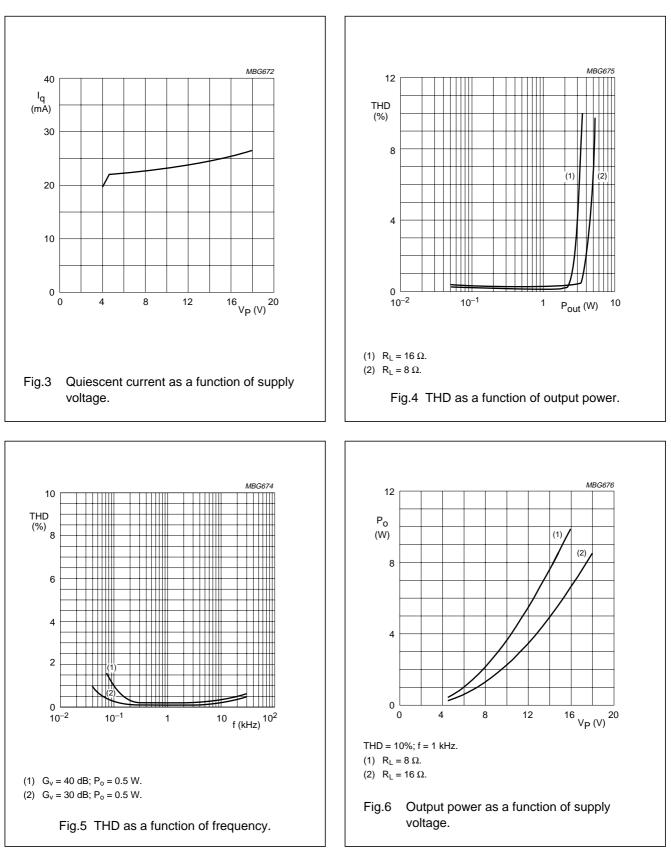
CHARACTERISTICS

 V_P = 12 V;T_{amb} = 25 °C; f_i = 1 kHz; R_L = 16 Ω ; unless otherwise specified (see Fig.13).

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
VP	voltage supply		4.5	_	18.5	V	
I _{q(tot)}	total quiescent current	V _P = 12 V; R _L = ∞; note 1	_	22	25	mA	
Maximum g	ain; V _{1,7} ≥ 1.4 V			ł			
Po	output power	THD = 10%; R_L = 16 Ω	3.0	3.5	-	W	
		THD = 10%; $R_L = 8 \Omega$	_	5.3	-	W	
		THD=10%; $R_L = 8 \Omega$; $V_P = 15 V$	-	8	-	W	
THD	total harmonic distortion	P _o = 0.5 W	_	0.3	1	%	
G _v	voltage gain		39.5	40.5	41.5	dB	
V _{i(rms)}	input signal handling (RMS value) $G_v = 0 \text{ dB}$; THD < 1%		1	-	-	V	
V _{o(n)}	noise output voltage	f _i = 500 kHz; note 2	_	210	_	μV	
В	bandwidth	at –1 dB	_	note 3	-	dB	
SVRR	supply voltage ripple rejection	note 4	34	38	-	dB	
V _{OS}	DC output offset voltage	V ₁₃ - V ₁₁ and V ₁₀ - V ₈	_	0	200	mV	
Zi	input impedance (pins 3 and 5)		15	20	25	kΩ	
α _{cs}	channel separation	$R_{S} = 5 k\Omega$	40	_	-	dB	
G _v	channel unbalance	note 5	_	_	1	dB	
		G ₁ = 0 dB; note 6	_	_	1	dB	
Mute positio	on; V ₁ = V ₇ =0.4 V ±30 mV		•		•		
V _{o(mute)}	output voltage in mute position	V _i = 1.0 V; note 7	_	35	45	μV	
DC volume	control						
ΔG_v	gain control range		68	73.5	-	dB	
I _{DC}	volume control current	$V_1 = V_7 = 0 V$	-20	-25	-30	μA	

Notes

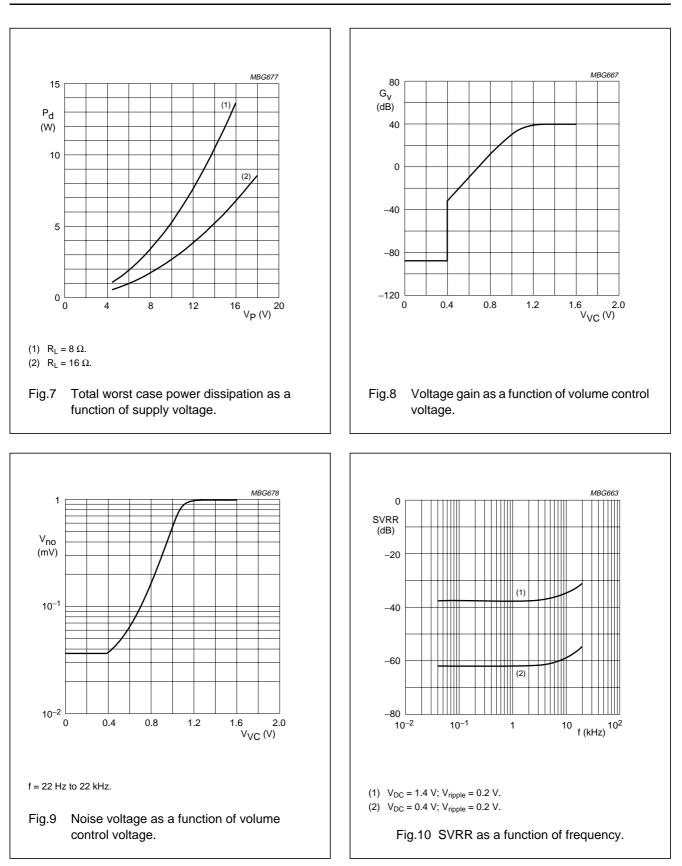
- 1. With a load connected to the outputs the quiescent current will increase, the maximum value of this increase being equal to the DC output offset voltage divided by R_L.
- 2. The noise output voltage (RMS value) at f_i = 500 kHz is measured with R_S = 0 Ω and bandwidth = 5 kHz.
- 3. 20 Hz to 300 kHz (typical.
- 4. The ripple rejection is measured with $R_S = 0 \Omega$ and f = 100 Hz to 10 kHz. The ripple voltage ($V_{ripple} = 200 \text{ mV RMS}$) is applied to the positive supply rail.
- 5. The channel unbalance is measured with V_{DC1} = $V_{DC2}.$
- 6. The channel unbalance at $G_1 = 0$ dB is measured with $V_{DC1} = V_{DC2}$.
- 7. The noise output voltage (RMS value) is measured with $R_S = 5 k\Omega$ unweighted.

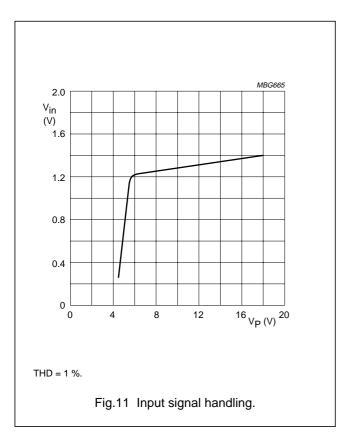


TDA7057AQ

TDA7057AQ

2×8 W stereo BTL audio output amplifier with DC volume control





APPLICATION INFORMATION

The application diagram is illustrated in Fig.13.

Test conditions

 $\label{eq:Tamb} \begin{array}{l} T_{amb} = 25 \ ^{\circ}C \ \text{unless otherwise specified; } V_{P} = 12 \ \text{V;} \\ V_{DC} = 1.4 \ \text{V; } f_{i} = 1 \ \text{kHz; } R_{L} = 16 \ \Omega. \end{array}$

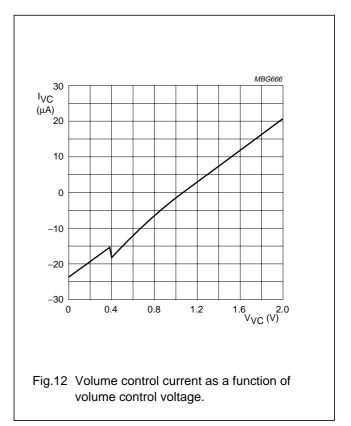
The quiescent current has been measured without load impedance.

The output power as a function of the supply voltage has been measured at THD = 10%. The maximum output power is limited by the maximum power dissipation and the maximum available output current.

The maximum input signal voltage is measured at THD = 1% at the output with a voltage gain of 0 dB.

To avoid instabilities and too high a distortion, the input ground and power ground must be separated as far as possible and connected as close as possible to the IC.

The DC volume control can be applied in several ways. Two possible circuits are shown below the main application diagram. The circuits at the control pin will influence the switch-on and switch-off behaviour and the maximum voltage gain.



For single-end applications the output peak current must not exceed 100 mA. At higher output currents the short-circuit protection (MCL) will be active.

Thermal considerations:

At high junction temperatures (>125 $^{\circ}$ C) the voltage gain will decrease when it is higher than 0 dB. This results in a decrease of the output voltage and an increase of the distortion level. Thus for an optimal performance of the IC the heatsink has to be designed properly.

Calculation example for application: V_P = 15 V; R_L = 8 Ω , stereo sine wave; worst case sine wave power dissipation is 12 W.

For T_{amb(max)} = 40 °C the thermal resistance from junction

to ambient
$$R_{th j-a} = \frac{(125 - 40)}{12} = 7.1 \text{ K/W}$$

The thermal resistance of the heatsink becomes:

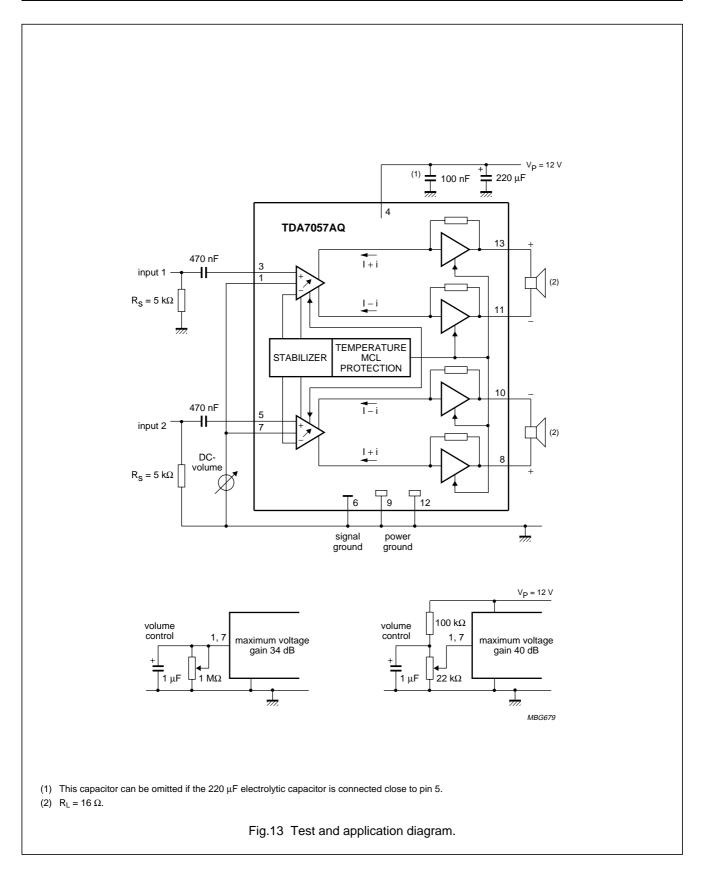
$$R_{\text{th h-a}} = R_{\text{th j-a}} - (R_{\text{th j-c}} + R_{\text{th c-h}});$$

$$R_{\text{th h-a}} = 7.1 - (4 + 0.1) = 3 \text{ K/W}.$$

It should be noted that for 'music power' the power dissipation will be approximately half of the sine wave dissipation. Thus a smaller heatsink can be used.

TDA7057AQ





TDA7057AQ

2×8 W stereo BTL audio output amplifier with DC volume control

PACKAGE OUTLINE

S13P:	plas	stic C	DIL-be	ent-S	IL po	wer	pack	age;	13 le	ads ((lead	leng	th 12	mm)						SC	DT14
					D							non-co □ ↓ E _h —									
-				_ `	d				↓ j									v (M)			
IMENSI	IONS (mm ai	re the c	origina	l dime	nsions	.)		0	5 l sca		10 m 	m								
UNIT	A	A ₂	b _p	c	D ⁽¹⁾	d	D _h	E ⁽¹⁾	е	e ₁	e ₂	E _h	j	L	L ₃	m	Q	v	w	x	Z ⁽¹⁾
mm	17.0 15.5	4.6 4.2	0.75 0.60	0.48 0.38	24.0 23.6	20.0 19.6	10	12.2 11.8	3.4	1.7	5.08	6	3.4 3.1	12.4 11.0	2.4 1.6	4.3	2.1 1.8	0.8	0.25	0.03	2.00 1.45
			trusion	s of 0.2	5 mm	maxim	um pei	r side ar REFE			ed.]		EUR	OPEA	N			
ou	OUTLINE VERSION																				
OU VE	RSION	1		IEC			JEDE	EC		EIA	٩J					PRO	JECTIO	ON	133	UE DA	IE

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status							
Objective specification	This data sheet contains target or goal specifications for product development.						
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.						
Product specification	This data sheet contains final product specifications.						
Limiting values							
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or							

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

TDA7057AQ

Product specification

2×8 W stereo BTL audio output amplifier with DC volume control

TDA7057AQ

NOTES

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NOTES

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Printed in The Netherlands

545102/1200/04/pp16

Date of release: 1998 Apr 07

Document order number: 9397 750 03255

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